

Key performance:

- $V_{CE}=1200V$
- $I_C=35A@T_C=100^\circ C$
- $V_{CE(sat)}=1.75 V$

Benefits:

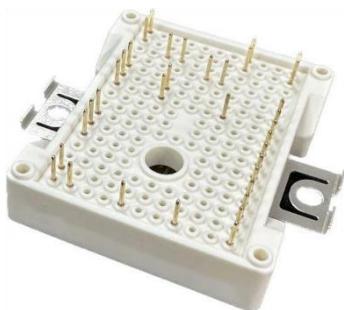
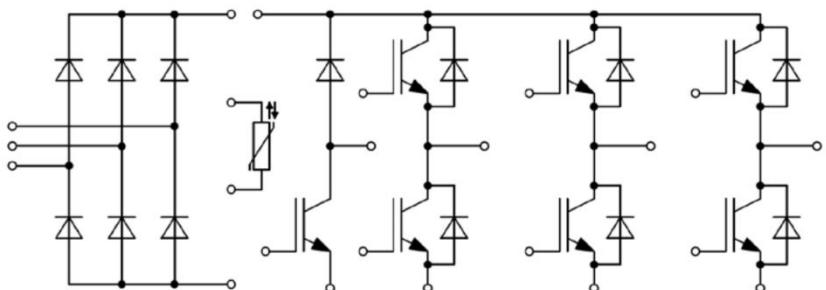
- High efficiency for application
- Convenient for mounting
- RoHS compliant.

Features:

- Low V_{CEsat}
- Low switching losses
- Low stray inductance design
- Positive V_{CEsat} temperature coefficient
- 10us short circuits capability

Applications:

- Motor drives
- Servo drives
- Auxiliary inverters

Typical Appearance:**Equivalent Circuit Schematic:**

IGBT, Inverter

Maximum rated values

Parameter	Conditions	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^\circ\text{C}$	V_{CES}	1200	V
Continuous collector current	$T_C = 100^\circ\text{C}, T_{vj \max} = 175^\circ\text{C}$	I_C	35	A
Repetitive peak collector current	$t_p = 1 \text{ ms}$	I_{CRM}	70	A
Total power dissipation	$T_C = 25^\circ\text{C}, T_{vj \max} = 175^\circ\text{C}$	P_{tot}	214	W
Gate-emitter peak voltage		V_{GES}	± 20	V

Characteristic values

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$I_C = 35\text{A}, V_{GE} = 15 \text{ V}, T_{vj} = 25^\circ\text{C}$	V_{CEsat}	-	1.75	-	V
	$I_C = 35\text{A}, V_{GE} = 15 \text{ V}, T_{vj} = 125^\circ\text{C}$		-	2.05	-	
	$I_C = 35\text{A}, V_{GE} = 15 \text{ V}, T_{vj} = 150^\circ\text{C}$		-	2.15	-	
Gate threshold voltage	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	V_{GEth}	-	5.7	-	V
Gate charge	$V_{GE} = -15 / 15 \text{ V}$	Q_G	-	0.68	-	μC
Input capacitance	$f = 1 \text{ MHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}	-	3.15	-	nF
Reverse transfer capacitance		C_{res}	-	27.5	-	pF
Collector-emitter leakage current	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^\circ\text{C}$	I_{CES}	-	-	1.0	mA
Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^\circ\text{C}$	I_{GES}	-	-	500	nA
Turn-on delay time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}, T_{vj} = 25^\circ\text{C}$	$t_{d(on)}$	-	30	-	ns
	$V_{GE} = -15 / 15 \text{ V}, T_{vj} = 125^\circ\text{C}$		-	34	-	
	$R_G = 5.1\Omega, T_{vj} = 150^\circ\text{C}$		-	36	-	
Rise time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}, T_{vj} = 25^\circ\text{C}$	t_r	-	40	-	ns
	$V_{GE} = -15 / 15 \text{ V}, T_{vj} = 125^\circ\text{C}$		-	44	-	
	$R_G = 5.1\Omega, T_{vj} = 150^\circ\text{C}$		-	46	-	
Turn-off delay time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}, T_{vj} = 25^\circ\text{C}$	$t_{d(off)}$	-	191	-	ns
	$V_{GE} = -15 / 15 \text{ V}, T_{vj} = 125^\circ\text{C}$		-	227	-	
	$R_G = 12\Omega, T_{vj} = 150^\circ\text{C}$		-	239	-	
Fall time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}, T_{vj} = 25^\circ\text{C}$	t_f	-	95	-	ns
	$V_{GE} = -15 / 15 \text{ V}, T_{vj} = 125^\circ\text{C}$		-	143	-	
	$R_G = 5.1\Omega, T_{vj} = 150^\circ\text{C}$		-	188	-	

Characteristic values

Turn-on energy loss per pulse	$I_C = 35A$, $V_{CE} = 600V$ $T_{vj} = 25^\circ C$ $V_{GE} = -15 / 15V$ $T_{vj} = 125^\circ C$ $R_G = 5.1\Omega$ $T_{vj} = 150^\circ C$	E_{on}	-	2.5 3.9 4.4	-	mJ
Turn-off energy loss per pulse	$I_C = 35A$, $V_{CE} = 600V$ $T_{vj} = 25^\circ C$ $V_{GE} = -15 / 15V$ $T_{vj} = 125^\circ C$ $R_G = 5.1\Omega$ $T_{vj} = 150^\circ C$	E_{off}	-	1.7 2.6 2.8	-	mJ
SC data	$V_{GE} \leq 15V$, $V_{CC} = 800V$ $t_P \leq 10\mu s$, $T_{vj} = 25^\circ C$	I_{SC}	-	170	-	A
Thermal resistance, junction to case	per IGBT	R_{thJC}	-	-	0.7	K/W
Thermal resistance, case to heatsink	per IGBT	R_{thCH}	-	0.65	-	K/W
Temperature under switching conditions		$T_{vj op}$	-40	-	150	°C

Diode, Inverter

Maximum rated values

Parameter	Conditions	Symbol	Values			Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	V_{RRM}	1200			V
Continuous DC forward current		I_F	35			A
Repetitive peak forward current	$t_P = 1 ms$	I_{FRM}	70			A

Characteristic values

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F = 35A$, $V_{GE} = 0V$ $T_{vj} = 25^\circ C$	V_F	-	2.2	-	V
	$I_F = 35A$, $V_{GE} = 0V$ $T_{vj} = 125^\circ C$		-	1.9	-	
	$I_F = 35A$, $V_{GE} = 0V$ $T_{vj} = 150^\circ C$		-	1.8	-	
Peak reverse recovery current	$I_F = 35A$, $V_R = 600V$ $T_{vj} = 25^\circ C$	I_{RR}	-	15.8	-	A
	$V_{GE} = -15V$ $T_{vj} = 125^\circ C$		-	24.3	-	
	$- dI_F/dt = 650A/\mu s$ $T_{vj} = 150^\circ C$		-	27.2	-	
Recovered charge	$I_F = 35A$, $V_R = 600V$ $T_{vj} = 25^\circ C$	Q_{RR}	-	1.5	-	μC
	$V_{GE} = -15V$ $T_{vj} = 125^\circ C$		-	3.7	-	
	$- dI_F/dt = 650A/\mu s$ $T_{vj} = 150^\circ C$		-	4.8	-	
Reverse recovery energy	$I_F = 35A$, $V_R = 600V$ $T_{vj} = 25^\circ C$	E_{rec}	-	0.5	-	mJ
	$V_{GE} = -15V$ $T_{vj} = 125^\circ C$		-	1.1	-	
	$- dI_F/dt = 650A/\mu s$ $T_{vj} = 150^\circ C$		-	1.5	-	
Thermal resistance, junction to case	per diode	R_{thJC}	-	-	0.8	K/W
Thermal resistance, case to heatsink	per diode	R_{thCH}	-	-	0.7	K/W
Temperature under switching conditions		$T_{vj op}$	-40	-	150	°C

IGBT, Brake-Chopper

Maximum rated values

Parameter	Conditions	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^\circ\text{C}$	V_{CES}	1200	V
Continuous collector current	$T_C = 100^\circ\text{C}, T_{vj \max} = 175^\circ\text{C}$	I_C	35	A
Repetitive peak collector current	$t_p = 1 \text{ ms}$	I_{CRM}	70	A
Total power dissipation	$T_C = 25^\circ\text{C}, T_{vj \max} = 175^\circ\text{C}$	P_{tot}	214	W
Gate-emitter peak voltage		V_{GES}	± 20	V

Characteristic values

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$I_C = 35\text{A}, V_{GE} = 15 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	V_{CEsat}	-	1.75		V
	$I_C = 35\text{A}, V_{GE} = 15 \text{ V}$ $T_{vj} = 125^\circ\text{C}$			2.05	-	
	$I_C = 35\text{A}, V_{GE} = 15 \text{ V}$ $T_{vj} = 150^\circ\text{C}$			2.15		
Gate threshold voltage	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	V_{GEth}	-	5.7	-	V
Gate charge	$V_{GE} = -15 / 15 \text{ V}$	Q_G	-	0.68	-	μC
Input capacitance	$f = 1 \text{ MHz}, T_{vj} = 25^\circ\text{C},$ $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}	-	3.15	-	nF
Reverse transfer capacitance		C_{res}	-	27.5	-	pF
Collector-emitter leakage current	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V},$ $T_{vj} = 25^\circ\text{C}$	I_{CES}	-	-	1.0	mA
Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V},$ $T_{vj} = 25^\circ\text{C}$	I_{GES}	-	-	500	nA
Turn-on delay time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	$t_{d(on)}$	-	30		ns
	$V_{GE} = -15 / 15 \text{ V}$ $T_{vj} = 125^\circ\text{C}$			34	-	
	$R_G = 5.1\Omega$ $T_{vj} = 150^\circ\text{C}$			36		
Rise time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	t_r	-	40		ns
	$V_{GE} = -15 / 15 \text{ V}$ $T_{vj} = 125^\circ\text{C}$			44	-	
	$R_G = 5.1\Omega$ $T_{vj} = 150^\circ\text{C}$			46		
Turn-off delay time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	$t_{d(off)}$	-	191		ns
	$V_{GE} = -15 / 15 \text{ V}$ $T_{vj} = 125^\circ\text{C}$			227	-	
	$R_G = 12\Omega$ $T_{vj} = 150^\circ\text{C}$			239		
Fall time, inductive load	$I_C = 35\text{A}, V_{CE} = 600 \text{ V}$ $T_{vj} = 25^\circ\text{C}$	t_f	-	95		ns
	$V_{GE} = -15 / 15 \text{ V}$ $T_{vj} = 125^\circ\text{C}$			143	-	
	$R_G = 5.1\Omega$ $T_{vj} = 150^\circ\text{C}$			188		

Characteristic values

Turn-on energy loss per pulse	$I_C = 35A$, $V_{CE} = 600V$ $T_{vj} = 25^\circ C$ $V_{GE} = -15 / 15V$ $T_{vj} = 125^\circ C$ $R_G = 5.1\Omega$ $T_{vj} = 150^\circ C$	E_{on}	-	2.5 3.9 4.4	-	mJ
Turn-off energy loss per pulse	$I_C = 35A$, $V_{CE} = 600V$ $T_{vj} = 25^\circ C$ $V_{GE} = -15 / 15V$ $T_{vj} = 125^\circ C$ $R_G = 5.1\Omega$ $T_{vj} = 150^\circ C$	E_{off}	-	1.7 2.6 2.8	-	mJ
SC data	$V_{GE} \leq 15V$, $V_{CC} = 800V$ $t_P \leq 10\mu s$, $T_{vj} = 25^\circ C$	I_{SC}	-	170	-	A
Thermal resistance, junction to case	per IGBT	R_{thJC}	-	-	0.7	K/W
Thermal resistance, case to heatsink	per IGBT	R_{thCH}	-	0.65	-	K/W
Temperature under switching conditions		$T_{vj op}$	-40	-	150	°C

Diode, Brake-Chopper Maximum rated values

Parameter	Conditions	Symbol	Values		Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	V_{RRM}	1200		V
Continuous DC forward current		I_F	10		A
Repetitive peak forward current	$t_P = 1 ms$	I_{FRM}	20		A

Characteristic values

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F = 10A$, $V_{GE} = 0V$ $T_{vj} = 25^\circ C$	V_F	-	1.60	-	V
	$I_F = 10A$, $V_{GE} = 0V$ $T_{vj} = 125^\circ C$		-	1.35	-	
	$I_F = 10A$, $V_{GE} = 0V$ $T_{vj} = 150^\circ C$		-	1.25	-	
Peak reverse recovery current	$I_F = 10A$, $V_R = 600V$ $T_{vj} = 25^\circ C$	I_{RR}	-	17.5	-	A
	$V_{GE} = -15V$ $T_{vj} = 125^\circ C$		-	21.0	-	
	$-dI_F/dt = 750A/\mu s$ $T_{vj} = 150^\circ C$		-	22.3	-	
Recovered charge	$I_F = 10A$, $V_R = 600V$ $T_{vj} = 25^\circ C$	Q_{RR}	-	1.05	-	μC
	$V_{GE} = -15V$ $T_{vj} = 125^\circ C$		-	1.85	-	
	$-dI_F/dt = 750A/\mu s$ $T_{vj} = 150^\circ C$		-	2.06	-	
Reverse recovery energy	$I_F = 10A$, $V_R = 600V$ $T_{vj} = 25^\circ C$	E_{rec}	-	0.43	-	mJ
	$V_{GE} = -15V$ $T_{vj} = 125^\circ C$		-	0.58	-	
	$-dI_F/dt = 750A/\mu s$ $T_{vj} = 150^\circ C$		-	0.82	-	
Thermal resistance, junction to case	per diode	R_{thJC}	-	1.20	1.40	K/W
Thermal resistance, case to heatsink	per diode	R_{thCH}	-	1.15	-	K/W
Temperature under switching conditions		$T_{vj op}$	-40	-	150	°C

Diode, Rectifier

Maximum rated values

Parameter	Conditions	Symbol	Values		Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	V_{RRM}	1600		V
Maximum RMS current at rectifier output	$T_c = 100^\circ C$	I_F	35		A
Surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$	I_{FSM}	400		A
I^2t - value	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$	I^2t	800		A^2s

Characteristic values

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F=25 \text{ A}, T_{vj}=150^\circ C$	V_F	-	0.95	-	V
Reverse recovery energy	$V_R = 1600 \text{ V}, T_{vj}=150^\circ C$	I_R	-	1.0	-	mA
Thermal resistance, junction to case	per diode	R_{thJC}	-	0.85	0.9	K/W
Thermal resistance, case to heatsink	per diode	R_{thCH}	-	0.9	-	K/W
Temperature under switching conditions		$T_{vj op}$	-40	-	150	°C

NTC, Thermistor

Characteristic values

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$T_{NTC}=25^\circ C$	R_{25}	-	5	-	kΩ
Deviation of R100	$T_{NTC}=100^\circ C, R_{100}=493 \Omega$	$\Delta R/R$	-5	-	5	%
Power dissipation	$T_{NTC}=25^\circ C$	P_{25}	-	-	20	mW

Module characteristic values

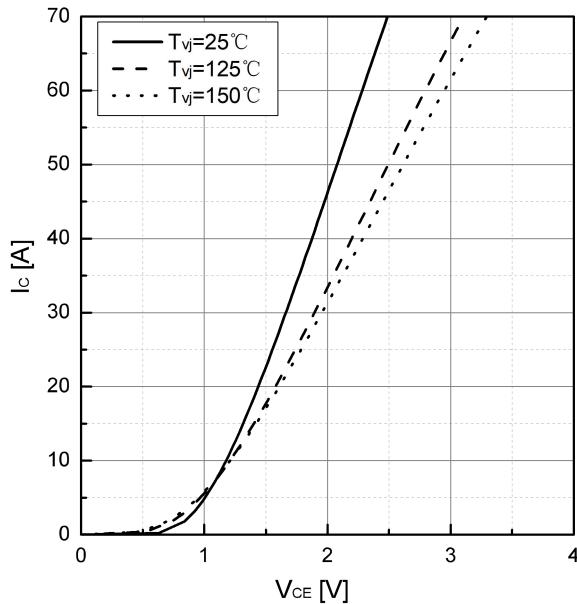
Parameter	Conditions	Symbol	Values	Unit
Isolation test voltage	RMS, f = 50 Hz, t = 1 min.	V _{ISOL}	2.5	kV
Internal isolation	basic insulation (class 1, IEC 61140)		Al ₂ O ₃	
Creepage distance	terminal to heatsink terminal to terminal		11.5 6.3	mm
Clearance	terminal to heatsink terminal to terminal		10 5	mm
Comperative tracking index		CTI	>200	

Parameter	Conditions	Symbol	Values	Unit
Isolation test voltage	RMS, f = 50 Hz, t = 1 min.	V _{ISOL}	2.5	kV
Internal isolation	basic insulation (class 1, IEC 61140)		Al ₂ O ₃	
Creepage distance	terminal to heatsink terminal to terminal		11.5 6.3	mm
Clearance	terminal to heatsink terminal to terminal		10 5	mm
Comperative tracking index		CTI	>200	

Output characteristic, IGBT

$$I_C = f(V_{CE})$$

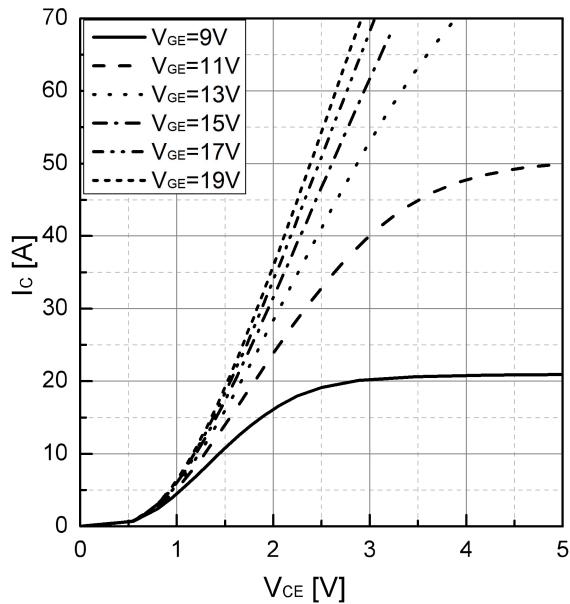
$V_{GE} = 15V$



Output characteristic, IGBT

$$I_C = f(V_{CE})$$

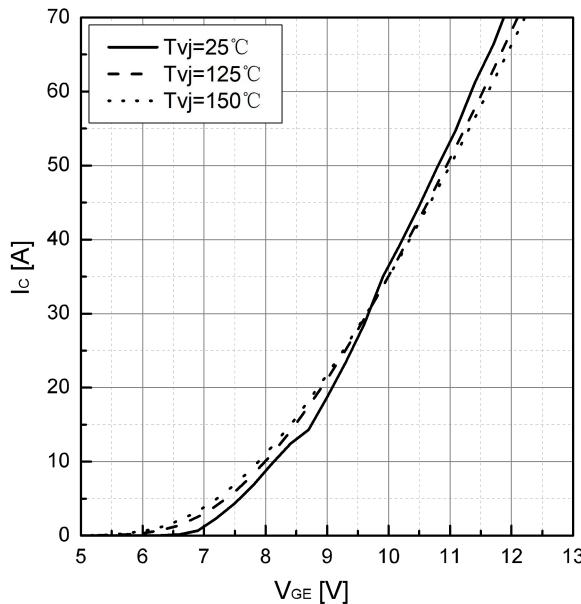
$T_{vj} = 150^\circ C$



Transfer characteristic, IGBT

$$I_C = f(V_{CE})$$

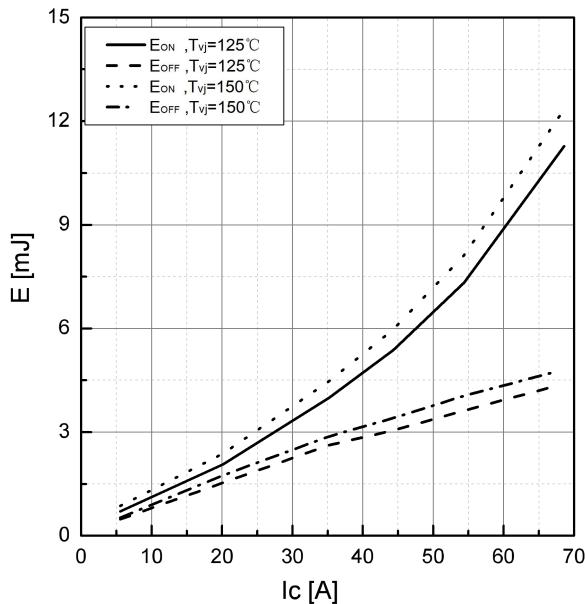
$V_{CE} = 20V$



Switching losses vs. I_C , IGBT

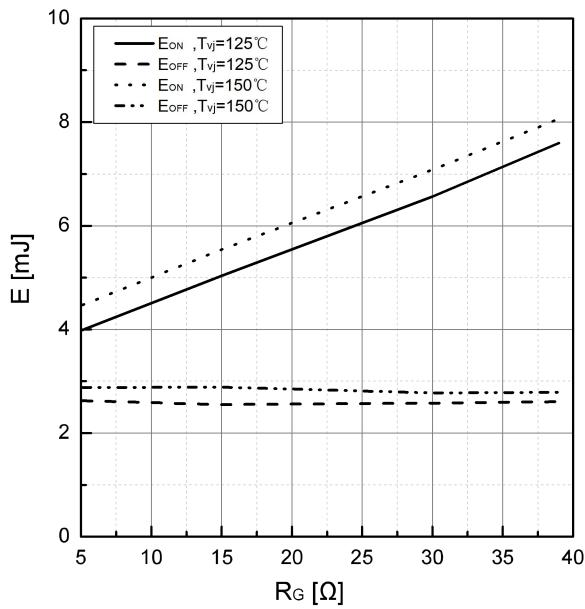
$$E_{on} = f(I_C), E_{off} = f(I_C)$$

$V_{CE} = 600V, V_{GE} = 15/-15V, R_G = 5.1 \Omega$



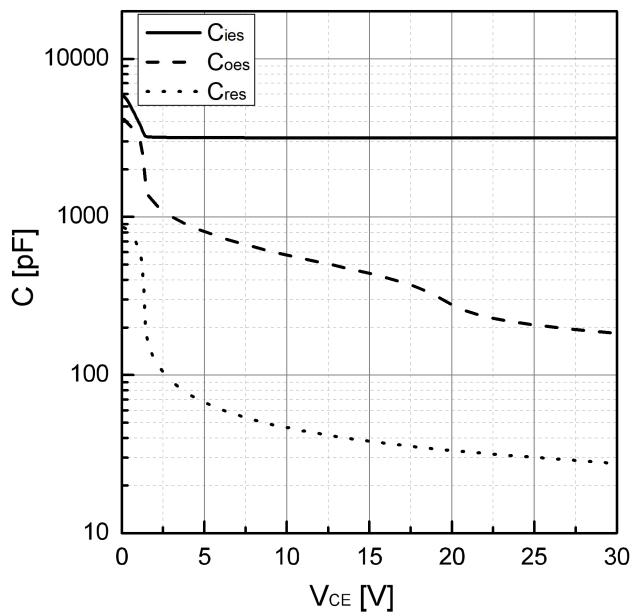
Switching losses vs. R_G , IGBT

$E_{on}=f(R_G)$, $E_{off}=f(R_G)$
 $V_{CE}=600V$, $V_{GE}=15/-15V$, $I_c=35A$



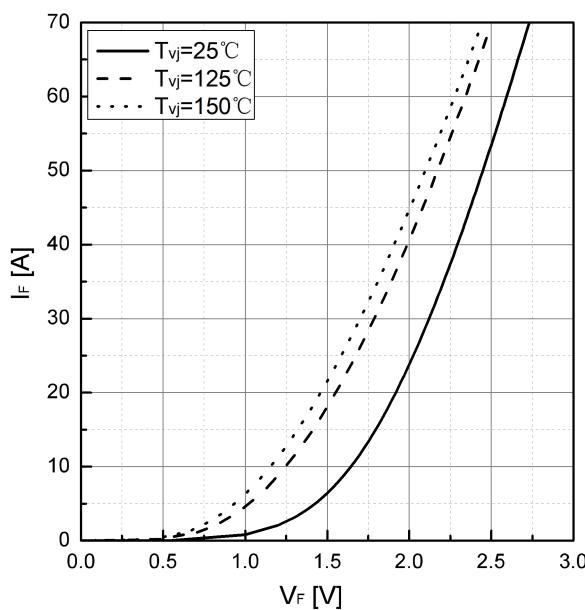
Capacity characteristic, IGBT

$C=f(V_{CE})$
 $f=100KHz$, $V_{GE}=0V$, $T_{vj}=25^{\circ}C$



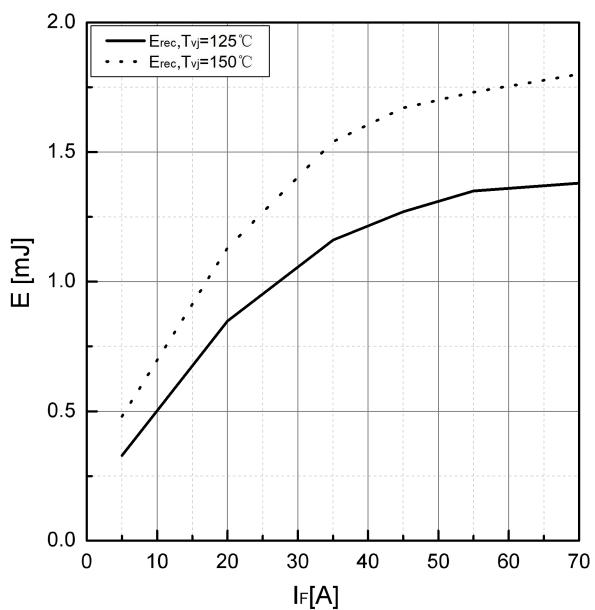
Forward characteristic, Diode

$I_F=f(V_F)$



Switching losses vs. I_F , Diode

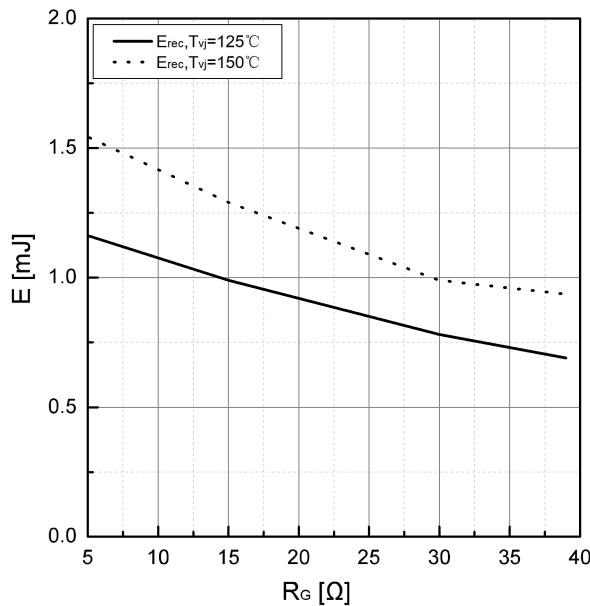
$E_{rec}=f(I_F)$
 $V_R=600V$, $R_G=5.1\Omega$



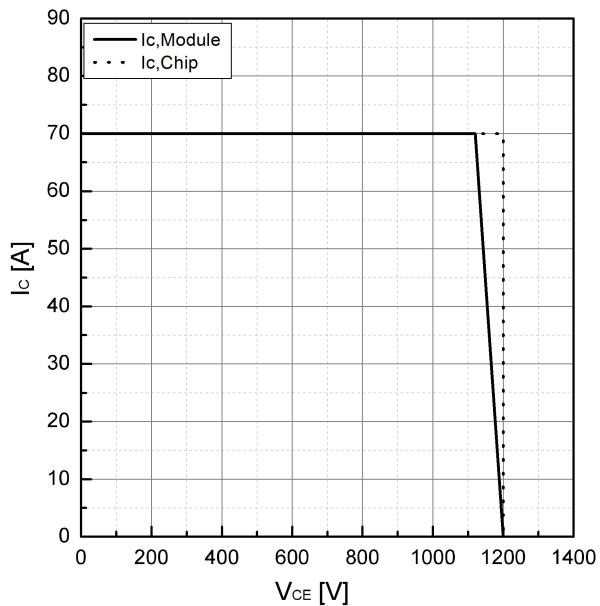
Switching losses vs. R_G, Diode

$$E_{rec} = f(R_G)$$

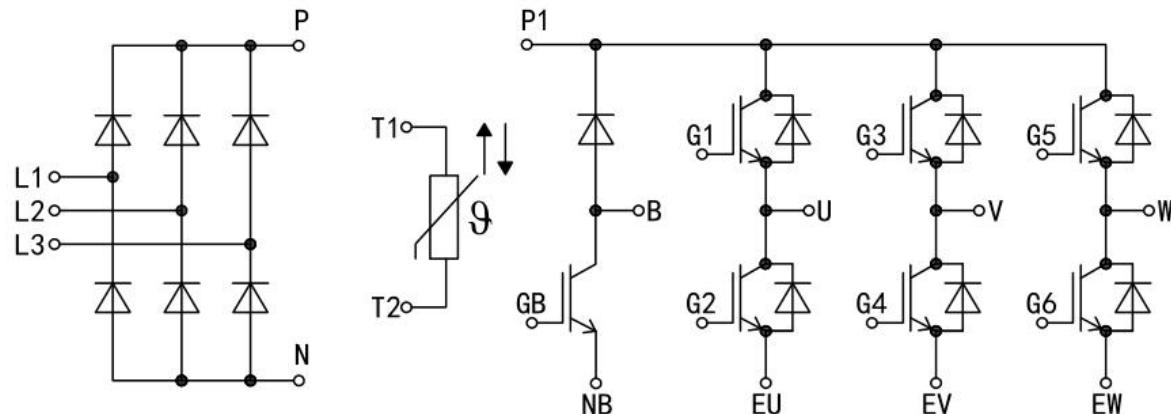
V_R=600V, I_F=35A

**Reverse bias safe operating area (RBSOA)**

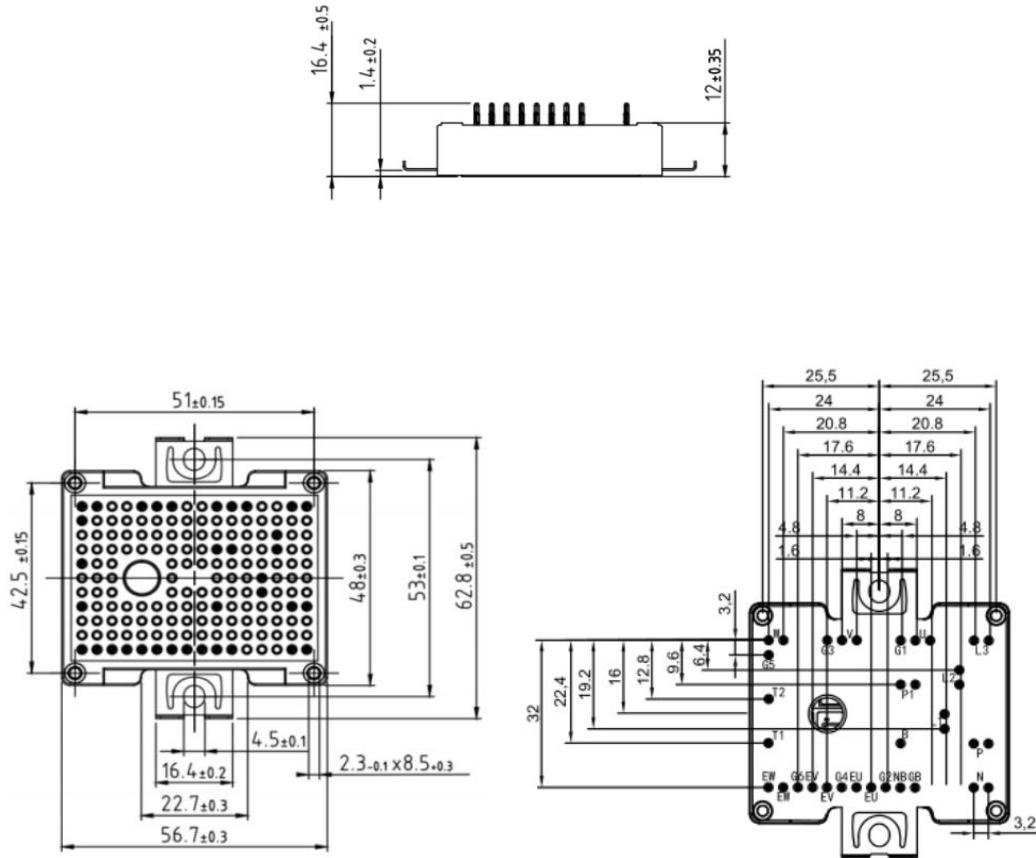
$$V_{CE}=600\text{V}, V_{GE}=15/-15\text{V}, R_G=5.1\ \Omega$$



Circuit diagram



Package outlines (mm)





Revision history

Date	Revision	Changes
Sep 17, 2024	Rev 1.0	Release of the final datasheet.

Disclaimer

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